

Overview

Xilinx is changing the humidity indicator card (HIC) used in the dry packing process.

Description

To comply with industry standard dry packing requirements, JEDEC standard J-STD-033, Xilinx is changing from a 6 dot HIC to a 3 dot HIC. This change is occurring in Q4CY2004.

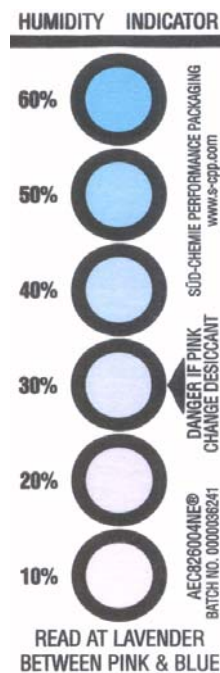


Figure 1: Before

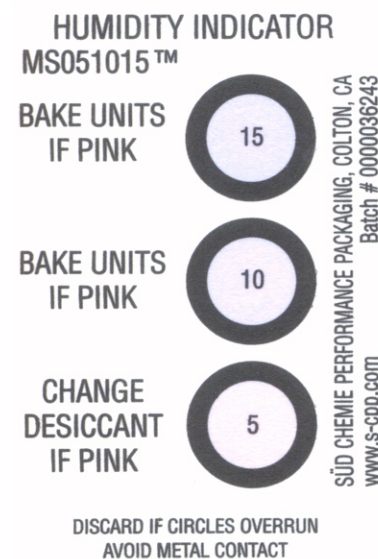


Figure 2: After

Products Affected

This change will affect all products that are dry packed.

Recommendation

No response is required to this PCN. For additional information or questions, please contact [Xilinx Technical Support](#).

Important Notice: Xilinx Customer Notifications (PCN, PDN, and Quality Alerts) can be delivered via e-mail alerts sent by the MySupport website (<http://www.xilinx.com/support>). Register today and personalize your "MyAlerts" to include Customer Notifications. This change provides many benefits, including the ability to receive alerts for new and updated information about specific products, as well as alerts for other publications such as data sheets, errata, application notes, and so forth. For instructions on how to sign up, refer to [Xilinx Answer Record 18683](#).

Revision History

The following table shows the revision history for this document.

Date	Version	Revision
12/6/04	1.0	Initial release of document.